

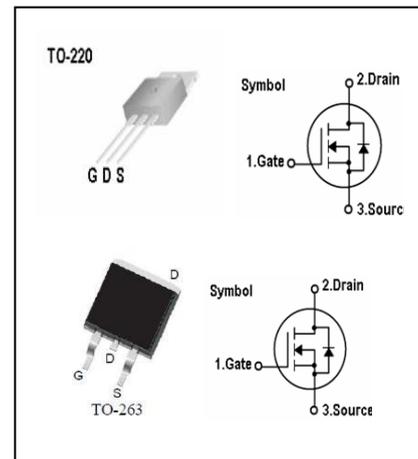
## N-Channel MOSFET

### Features

- 80V,100A,Rds(on)(typ)=5.8mΩ @Vgs=10V
- High Ruggedness
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

### General Description

This Power MOSFET is produced using Si-Tech's advanced Trench MOS Technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. These devices are well suited for low voltage application such as automotive, DC/DC converters, and high efficiency switch for power management in portable and battery products.



### Absolute Maximum Ratings

| Symbol           | Parameter  | Value       | Units |
|------------------|--|-------------|-------|
| V <sub>DSS</sub> | Drain-Source Voltage                             | 80          | V     |
| I <sub>D</sub>   | Continuous Drain Current (T <sub>c</sub> =25°C)  | 100         | A     |
|                  | Continuous Drain Current (T <sub>c</sub> =100°C) | 70          | A     |
| I <sub>DM</sub>  | Pulsed Drain Current (Note 1)                    | 320         | A     |
| V <sub>GS</sub>  | Gate-Source Voltage                              | ± 30        | V     |
| E <sub>AS</sub>  | Single Pulsed Avalanche Energy (Note 2)          | 784         | mJ    |
| P <sub>D</sub>   | Maximum Power Dissipation (T <sub>c</sub> =25°C) | 208         | W     |
|                  | Derating Factor above 25°C                       | 1.39        | W/°C  |
| T <sub>J</sub>   | Operating Junction Temperature Range             | -55 to +175 | °C    |
| T <sub>STG</sub> | Storage Temperature Range                        | -55 to +175 | °C    |

### Thermal Characteristics

| Symbol              | Parameter                               | Max. | Units |
|---------------------|---|------|-------|
| R <sub>th j-c</sub> | Thermal Resistance, Junction to case    | 0.72 | °C/W  |
| R <sub>th c-s</sub> | Thermal Resistance, Case to Sink        | 0.5  | °C/W  |
| R <sub>th j-a</sub> | Thermal Resistance, Junction to Ambient | 62.5 | °C/W  |

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

| Symbol              | Parameter                        | Test Conditions  | Min. | Typ. | Max. | Units |
|---------------------|----------------------------------|--|------|------|------|-------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage   | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA               | 80   | -    | -    | V     |
| I <sub>DSS</sub>    | Drain-Source Leakage Current     | V <sub>DS</sub> =78V, V <sub>GS</sub> =0V                | -    | -    | 1    | uA    |
| I <sub>GSS</sub>    | Gate Leakage Current, Forward    | V <sub>GS</sub> =30V, V <sub>DS</sub> =0V                | -    | -    | 100  | nA    |
|                     | Gate Leakage Current, Reverse    | V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V               | -    | -    | -100 | nA    |
| V <sub>GS(th)</sub> | Gate Threshold Voltage           | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA | 2    | -    | 4    | V     |
| R <sub>DS(on)</sub> | Drain-Source On-State Resistance | V <sub>GS</sub> =10V, I <sub>D</sub> =40A                | -    | 5.8  | 7    | mΩ    |
| Q <sub>g</sub>      | Total Gate Charge                | V <sub>DD</sub> =60V                                     | -    | 107  | -    | nC    |
| Q <sub>gs</sub>     | Gate-Source Charge               | V <sub>GS</sub> =10V                                     | -    | 26   | -    | nC    |
| Q <sub>gd</sub>     | Gate-Drain Charge                | I <sub>D</sub> =80A (Note 3)                             | -    | 46   | -    | nC    |
| t <sub>d(on)</sub>  | Turn-on Delay Time               | V <sub>DD</sub> =37.5V, V <sub>GS</sub> =10V             | -    | 25   | -    | ns    |
| t <sub>r</sub>      | Turn-on Rise Time                | I <sub>D</sub> =45A, R <sub>G</sub> =4.7Ω                | -    | 66   | -    | ns    |
| t <sub>d(off)</sub> | Turn-off Delay Time              | T <sub>C</sub> =25°C                                     | -    | 36   | -    | ns    |
| t <sub>f</sub>      | Turn-off Fall Time               | (Note 3)   | -    | 24   | -    | ns    |
| C <sub>iss</sub>    | Input Capacitance -              | V <sub>DS</sub> =25V                                     | -    | 4020 | -    | pF    |
| C <sub>oss</sub>    | Output Capacitance               | V <sub>GS</sub> =0V                                      | -    | 489  | -    | pF    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance     | f = 1MHz   | -    | 208  | -    | pF    |

**Source-Drain Diode Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

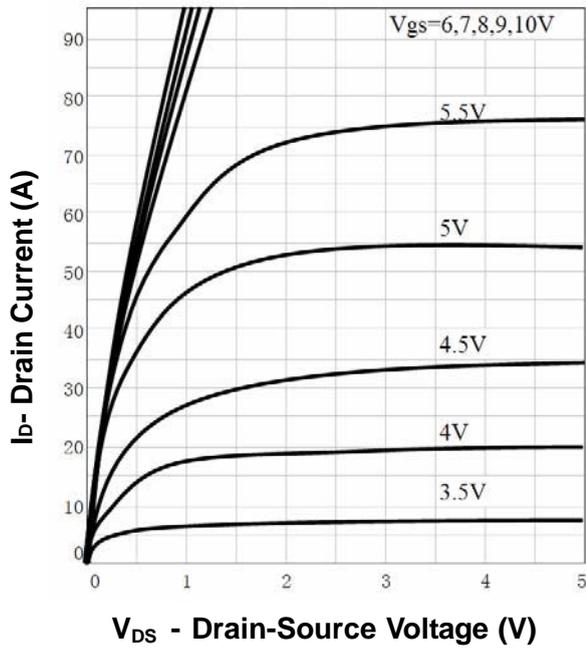
| Symbol          | Parameter                                    | Test Conditions                          | Min. | Typ. | Max. | Units |
|-----------------|--|--|------|------|------|-------|
| I <sub>S</sub>  | Continuous Source Diode Forward Current      |  | -    | -    | 100  | A     |
| I <sub>SM</sub> | Pulsed Source Diode Forward Current (Note 1) |  | -    | -    | 320  | A     |
| V <sub>SD</sub> | Forward On Voltage                           | V <sub>GS</sub> =0V, I <sub>S</sub> =45A | -    | -    | 1.2  | V     |
| t <sub>rr</sub> | Reverse Recovery Time                        | V <sub>GS</sub> =0V, I <sub>S</sub> =45A | -    | 100  | 150  | ns    |
| Q <sub>rr</sub> | Reverse Recovery Charge                      | dI <sub>F</sub> /dt = 100A/us            | -    | 410  | 650  | nC    |

Notes:

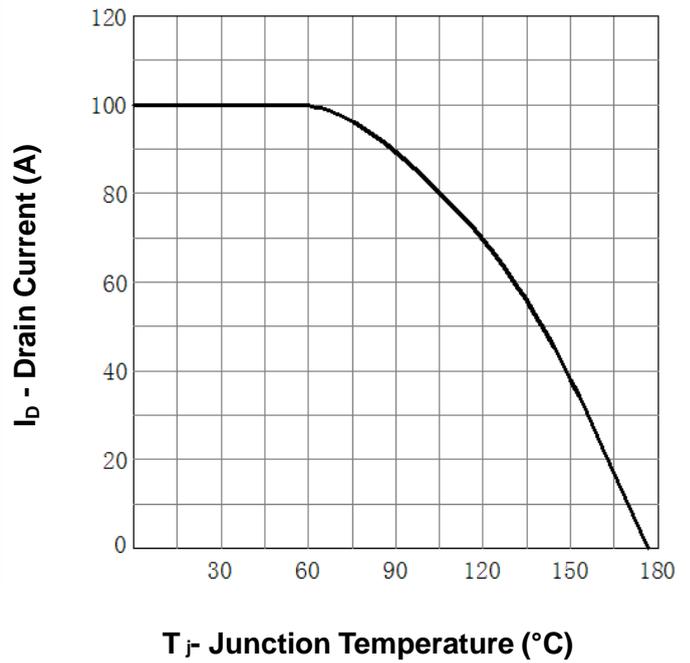
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L=0.5mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω, Starting T<sub>J</sub>=25°C
3. Pulse Width ≤ 300 us; Duty Cycle ≤ 2%

Typical Characteristics

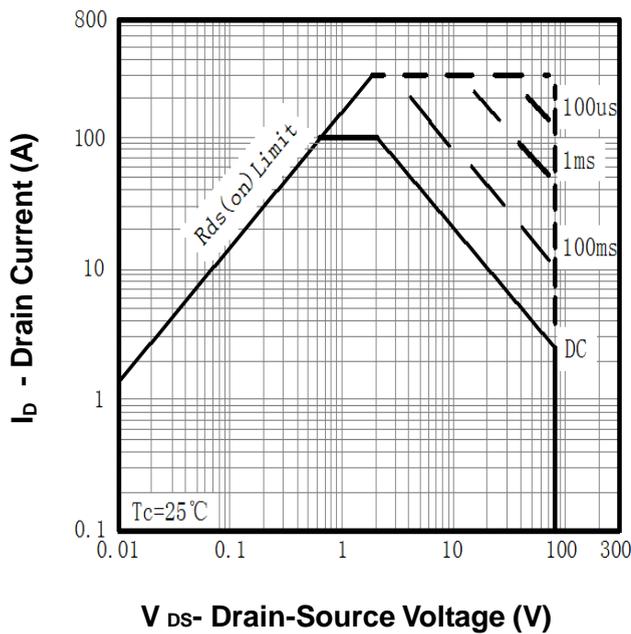
Output Characteristics



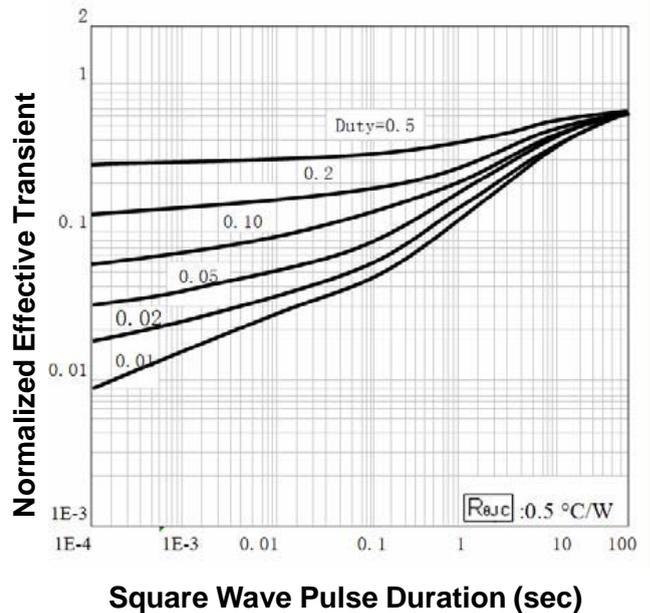
Drain Current



Safe Operation Area

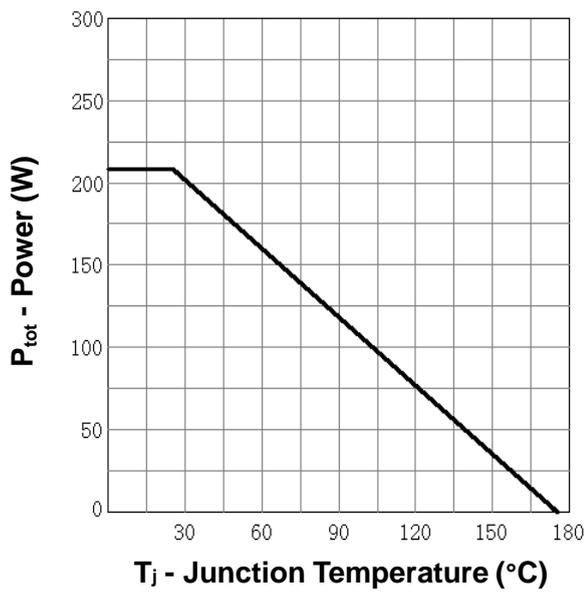


Thermal Transient Impedance

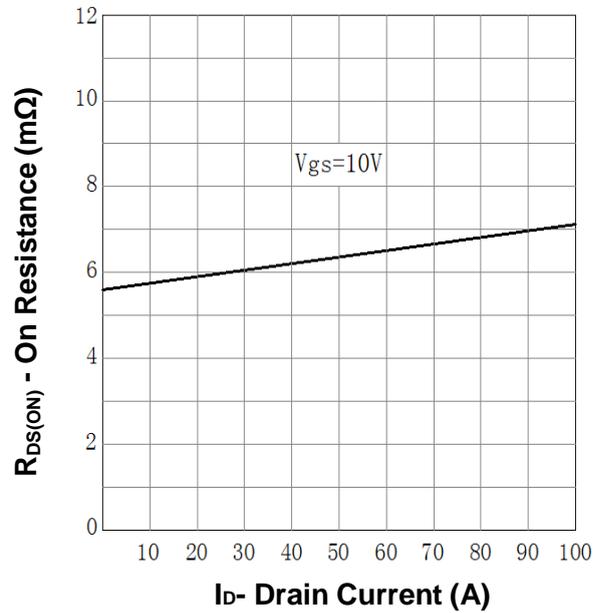


Typical Characteristics

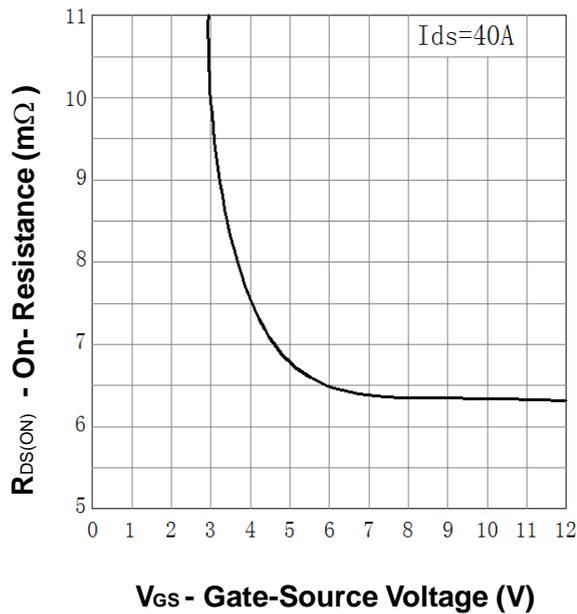
Power Dissipation



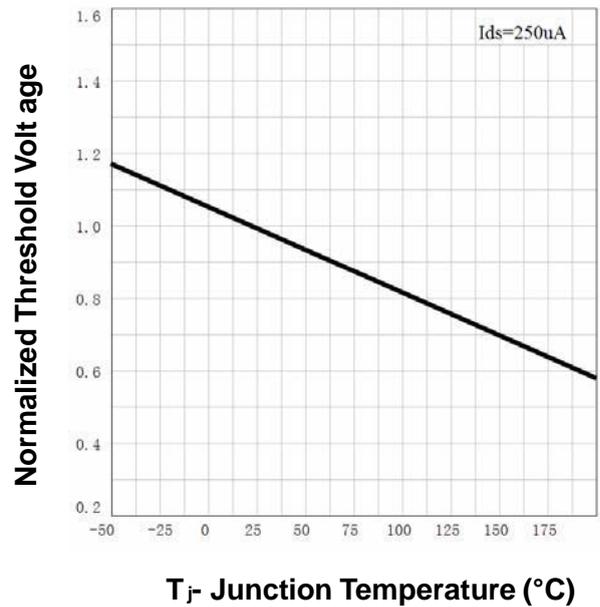
Drain-Source On Resistance



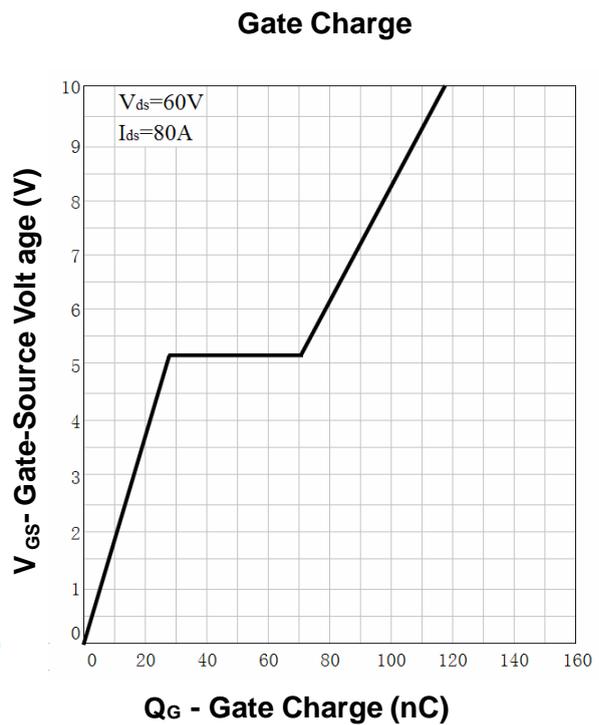
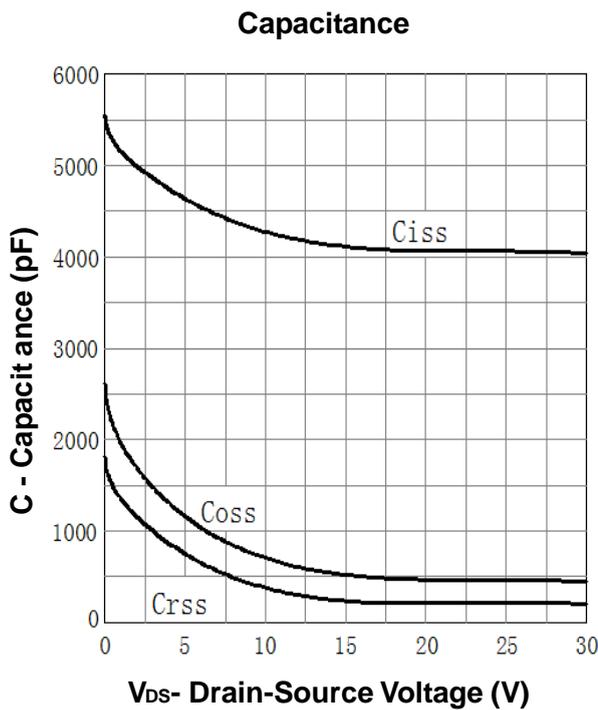
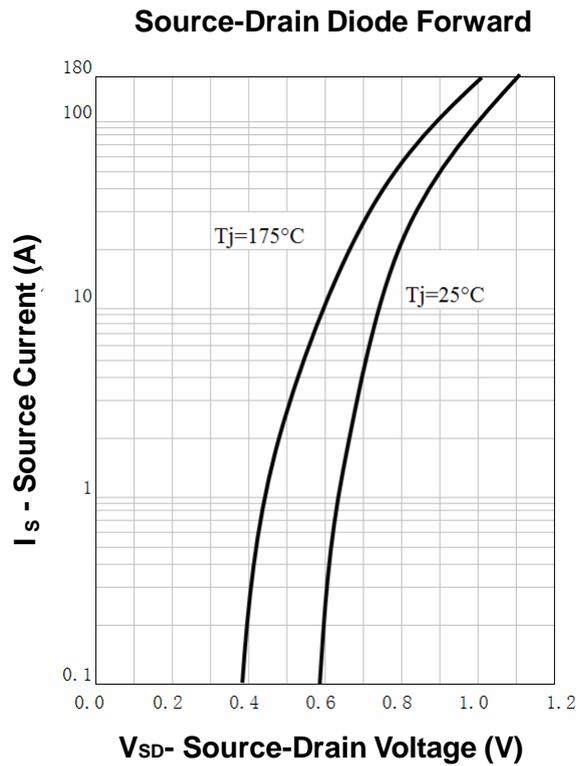
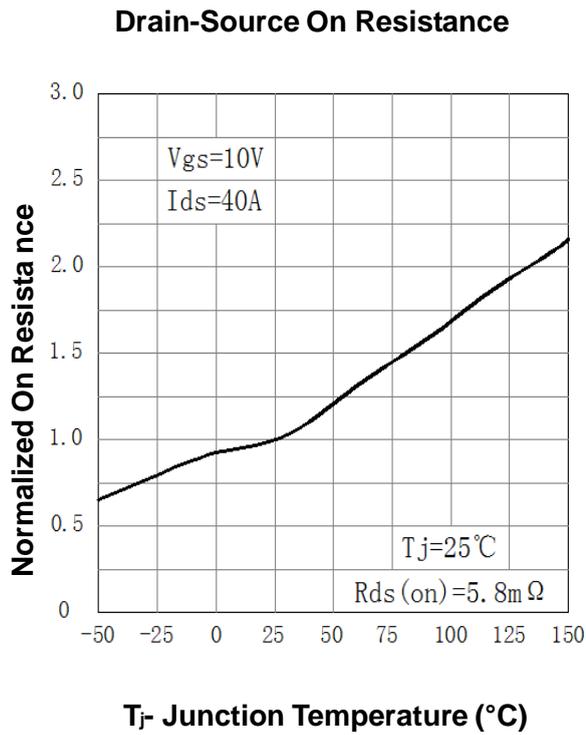
Drain-Source On Resistance



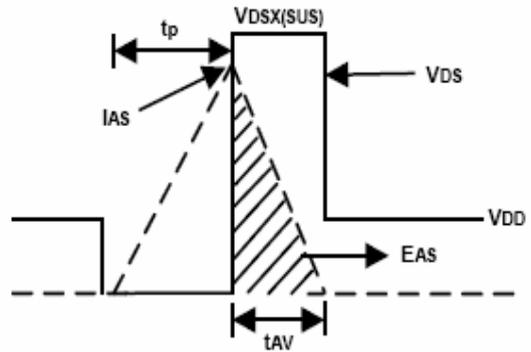
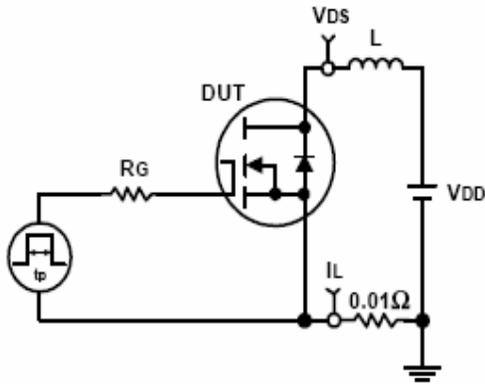
Gate Threshold Voltage



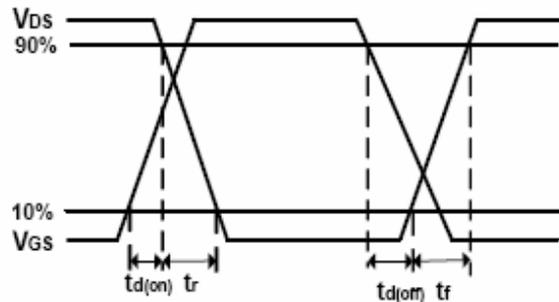
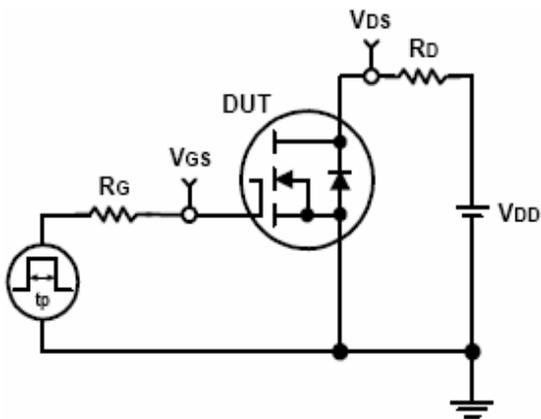
Typical Characteristics



### Avalanche Test Circuit and Waveforms



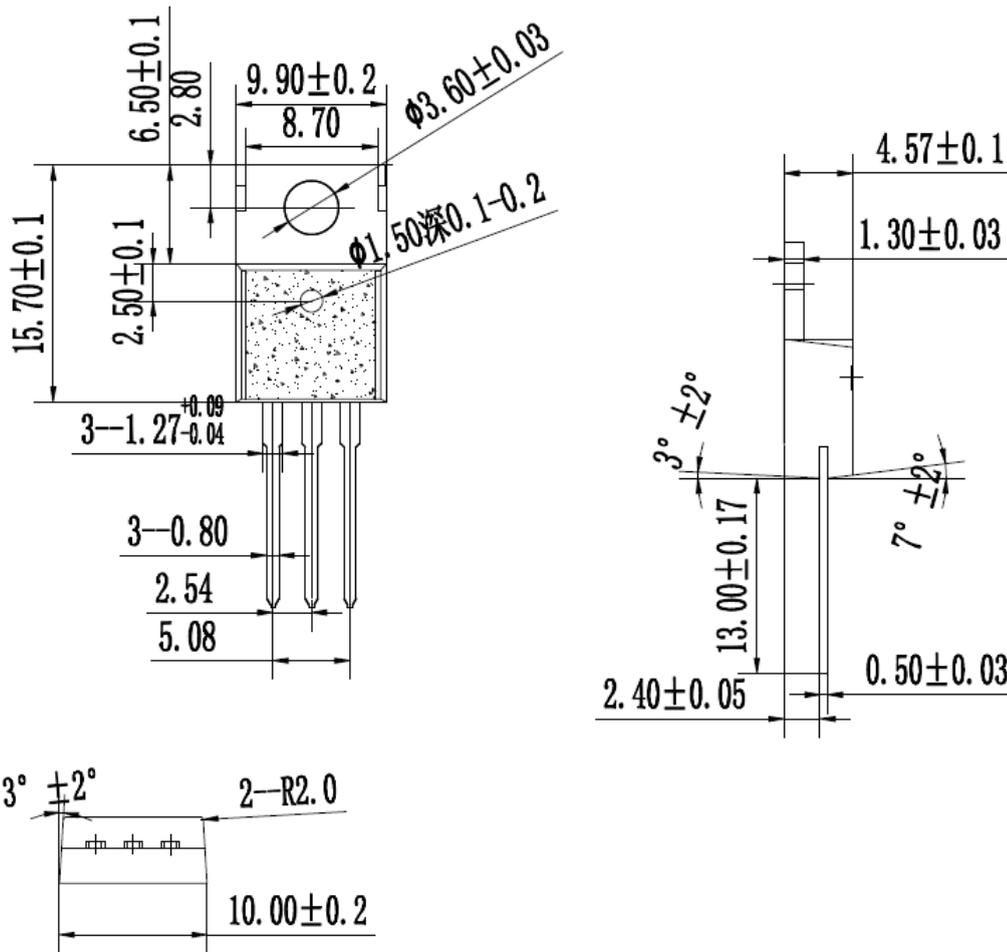
### Switching Time Test Circuit and Waveforms



Package Outline

Dimensions are shown in millimeters

R: TO220



S: TO263 (D<sup>2</sup>PAK)

